

STRUCTURE	Silicon monolithic integrated circuit
PRODUCT SERIES	H-bridge driver for DC brush motor
TYPE	<b>BD6222HFP</b>
FEATURES	<ul style="list-style-type: none"> <li>• Voltage setting pin enables for PWM duty control</li> <li>• Supports PWM control signal input</li> </ul>

○ ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Supply voltage	VCC	18	V
Output current	IOMAX	2.0 * <sup>1</sup>	A
All other input pins	VIN	-0.3 ~ VCC	V
Operating temperature	TOPR	-40 ~ +85	°C
Storage temperature	TSTG	-55 ~ +150	°C
Power dissipation	Pd	1.4 * <sup>2</sup>	W
Junction temperature	Tjmax	150	°C

\*\*\* Notes: All voltages are with respect to ground.

\*1 Do not exceed Pd or ASO.

\*2 Mounted on a 70mm x 70mm x 1.6mm FR4 glass-epoxy board with thermal via and 2.25% copper foil. Derated at 11.2mW/°C above 25°C.

○ OPERATING CONDITIONS (Ta=25°C)

Parameter	Symbol	Limits	Unit
Supply voltage	VCC	6 ~ 15	V
VREF voltage	VREF	3 ~ 15	V

This product is not designed for protection against radioactive rays.

Status of this document

The Japanese version of this document is the formal specification.

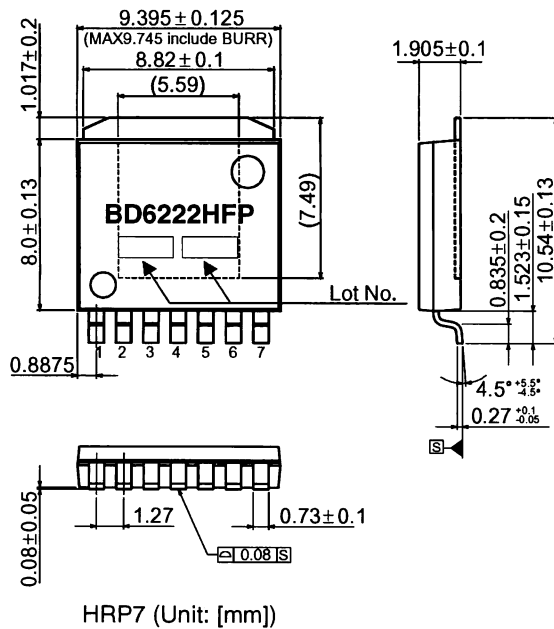
A customer may use this translation version only for a reference to help reading the formal version.

If there are any differences in translation version of this document, formal version takes priority.

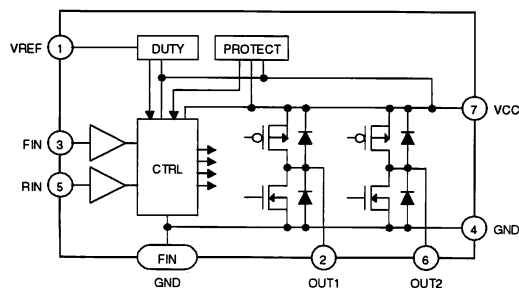
○ ELECTRICAL CHARACTERISTICS (Unless otherwise specified, Ta=25°C and VCC=VREF=12V)

Parameter	Symbol	Limits			Unit	Conditions
		Min.	Typ.	Max.		
Supply current	I <sub>CC</sub>	0.8	1.3	2.5	mA	Forward / Reverse / Brake
Stand-by current	I <sub>STBY</sub>	-	0	10	μA	Stand-by
Input high voltage	V <sub>IH</sub>	2.0	-	-	V	
Input low voltage	V <sub>IL</sub>	-	-	0.8	V	
Input bias current	I <sub>IH</sub>	30	50	100	μA	V <sub>IN</sub> =5.0V
Output ON resistance	R <sub>ON</sub>	0.5	1.0	1.5	Ω	I <sub>o</sub> =1.0A, vertically total
VREF bias current	I <sub>VREF</sub>	-10	0	10	μA	VREF=VCC
Carrier frequency	F <sub>PWM</sub>	20	25	35	kHz	VREF=9V
Input frequency range	F <sub>MAX</sub>	20	-	100	kHz	FIN / RIN

○ PHYSICAL DIMENSIONS AND MARKING



○ BLOCK DIAGRAM



○ PIN DESCRIPTIONS

Pin	Name
1	VREF
2	OUT1
3	FIN
4	GND
5	RIN
6	OUT2
7	VCC
FIN	GND

## O NOTES FOR USE

- 1) Absolute maximum ratings  
Devices may be destroyed when supply voltage or operating temperature exceeds the absolute maximum rating. Because the cause of this damage cannot be identified as, for example, a short circuit or an open circuit, it is important to consider circuit protection measures – such as adding fuses – if any value in excess of absolute maximum ratings is to be implemented.
- 2) Connecting the power supply connector backward  
Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply lines, such as adding an external direction diode.
- 3) Power supply lines  
Return current generated by the motor's Back-EMF requires countermeasures, such as providing a return current path by inserting capacitors across the power supply and GND. In this case, it is important to conclusively confirm that none of the negative effects sometimes seen with electrolytic capacitors – including a capacitance drop at low temperatures - occurs. Also, the connected power supply must have sufficient current absorbing capability. Otherwise, the regenerated current will increase voltage on the power supply line, which may in turn cause problems with the product, including peripheral circuits exceeding the absolute maximum rating. To help protect against damage or degradation, physical safety measures should be taken, such as providing a voltage clamping diode across the power supply and GND.
- 4) Electrical potential at GND  
Keep the GND terminal potential to the minimum potential under any operating condition. In addition, check to determine whether there is any terminal that provides voltage below GND, including the voltage during transient phenomena. When both a small signal GND and high current GND are present, single-point grounding (at the set's reference point) is recommended, in order to separate the small signal and high current GND, and to ensure that voltage changes due to the wiring resistance and high current do not affect the voltage at the small signal GND. In the same way, care must be taken to avoid changes in the GND wire pattern in any external connected component.
- 5) Thermal design  
Use a thermal design that allows for a sufficient margin in light of the power dissipation (Pd) under actual operating conditions.
- 6) Inter-pin shorts and mounting errors  
Use caution when positioning the IC for mounting on printed circuit boards. The IC may be damaged if there is any connection error, or if pins are shorted together.
- 7) Operation in strong electromagnetic fields  
Using this product in strong electromagnetic fields may cause IC malfunctions. Use extreme caution with electromagnetic fields.
- 8) ASO - Area of Safety Operation  
When using the IC, set the output transistor so that it does not exceed absolute maximum ratings or ASO.
- 9) Built-in thermal shutdown (TSD) circuit  
The TSD circuit is designed only to shut the IC off to prevent thermal runaway. It is not designed to protect the IC or guarantee its operation in the presence of extreme heat. Do not continue to use the IC after the TSD circuit is activated, and do not operate the IC in an environment where activation of the circuit is assumed.
- 10) Capacitor between output and GND  
In the event a large capacitor is connected between the output and GND, if VCC and VIN are short-circuited with 0V or GND for any reason, the current charged in the capacitor flows into the output and may destroy the IC. Use a capacitor smaller than 1 $\mu$ F between output and GND.
- 11) Testing on application boards  
When testing the IC on an application board, connecting a capacitor to a low impedance pin subjects the IC to stress. Therefore, always discharge capacitors after each process or step. Always turn the IC's power supply off before connecting it to or removing it from the test setup during the inspection process. Ground the IC during assembly steps as an antistatic measure. Use similar precaution when transporting or storing the IC.

### Notes

- No technical content pages of this document may be reproduced in any form or transmitted by any means without prior permission of ROHM CO.,LTD.
- The contents described herein are subject to change without notice. The specifications for the product described in this document are for reference only. Upon actual use, therefore, please request that specifications to be separately delivered.
- Application circuit diagrams and circuit constants contained herein are shown as examples of standard use and operation. Please pay careful attention to the peripheral conditions when designing circuits and deciding upon circuit constants in the set.
- Any data, including, but not limited to application circuit diagrams information, described herein are intended only as illustrations of such devices and not as the specifications for such devices. ROHM CO.,LTD. disclaims any warranty that any use of such devices shall be free from infringement of any third party's intellectual property rights or other proprietary rights, and further, assumes no liability of whatsoever nature in the event of any such infringement, or arising from or connected with or related to the use of such devices.
- Upon the sale of any such devices, other than for buyer's right to use such devices itself, resell or otherwise dispose of the same, no express or implied right or license to practice or commercially exploit any intellectual property rights or other proprietary rights owned or controlled by
- ROHM CO., LTD. is granted to any such buyer.
- Products listed in this document are no antiradiation design.

The products listed in this document are designed to be used with ordinary electronic equipment or devices (such as audio visual equipment, office-automation equipment, communications devices, electrical appliances and electronic toys).

Should you intend to use these products with equipment or devices which require an extremely high level of reliability and the malfunction of which would directly endanger human life (such as medical instruments, transportation equipment, aerospace machinery, nuclear-reactor controllers, fuel controllers and other safety devices), please be sure to consult with our sales representative in advance.

#### About Export Control Order in Japan

Products described herein are the objects of controlled goods in Annex 1 (Item 16) of Export Trade Control Order in Japan.

In case of export from Japan, please confirm if it applies to "objective" criteria or an "informed" (by MITI clause) on the basis of "catch all controls for Non-Proliferation of Weapons of Mass Destruction.

Thank you for your accessing to ROHM product informations.  
More detail product informations and catalogs are available,  
please contact your nearest sales office.

Please contact our sales offices for details ;

U.S.A / San Diego	TEL : +1(858)625-3630	FAX : +1(858)625-3670
Atlanta	TEL : +1(770)754-5972	FAX : +1(770)754-0691
Dallas	TEL : +1(972)312-8818	FAX : +1(972)312-0330
Germany / Dusseldorf	TEL : +49(2154)9210	FAX : +49(2154)921400
United Kingdom / London	TEL : +44(1)908-282-666	FAX : +44(1)908-282-528
France / Paris	TEL : +33(0)1 56 97 30 60	FAX : +33(0) 1 56 97 30 80
China / Hong Kong	TEL : +852(2)740-6262	FAX : +852(2)375-8971
Shanghai	TEL : +86(21)6279-2727	FAX : +86(21)6247-2066
Dilian	TEL : +86(411)8230-8549	FAX : +86(411)8230-8537
Beijing	TEL : +86(10)8525-2483	FAX : +86(10)8525-2489
Taiwan / Taipei	TEL : +866(2)2500-6956	FAX : +866(2)2503-2869
Korea / Seoul	TEL : +82(2)8182-700	FAX : +82(2)8182-715
Singapore	TEL : +65-6332-2322	FAX : +65-6332-5662
Malaysia / Kuala Lumpur	TEL : +60(3)7958-8355	FAX : +60(3)7958-8377
Philippines / Manila	TEL : +63(2)807-6872	FAX : +63(2)809-1422
Thailand / Bangkok	TEL : +66(2)254-4890	FAX : +66(2)256-6334

Japan /  
(Internal Sales)

Tokyo	2-1-1, Yaesu, Chuo-ku, Tokyo 104-0082	TEL : +81(3)5203-0321	FAX : +81(3)5203-0300
Yokohama	2-4-8, Shin Yokohama, Kohoku-ku, Yokohama, Kanagawa 222-8575	TEL : +81(45)476-2131	FAX : +81(45)476-2128
Nagoya	Dainagayo Building 9F 3-28-12, Meieki, Nakamura-ku, Nagoya, Aichi 450-0002	TEL : +81(52)581-8521	FAX : +81(52)561-2173
Kyoto	579-32 Higashi Shiokouji-cho, Karasuma Nishi-iru, Shiokoujidori, Shimogyo-ku, Kyoto 600-8216	TEL : +81(75)311-2121	FAX : +81(75)314-6559

(Contact address for overseas customers in Japan)

Yokohama	TEL : +81(45)476-9270	FAX : +81(045)476-9271
----------	-----------------------	------------------------